## CMR1U-13M

SURFACE MOUNT SILICON **ULTRA FAST RECOVERY RECTIFIER** 1.0 AMP, 1300 VOLT



**APPLICATIONS:** 

**Thermal Resistance** 

 $I_R$ 

 $V_{F}$ 

trr CJ

BVR

V<sub>R</sub>=1300V

I<sub>R</sub>=0.5mA

I<sub>F</sub>=1.0A

· Freewheeling diode

· Power factor correction

· Power supply snubber

# **-e** 'n Semiconductor Corp

www.centralsemi.com

UNITS V V V А

А

°C

°C/W

UNITS

μA

V

V

ns

pF

# **DESCRIPTION:**

The CENTRAL SEMICONDUCTOR CMR1U-13M is a highly reliable 1.0 Amp silicon Ultra Fast Recovery rectifier designed for use in all types of high voltage applications where small size is required.

### MARKING CODE: CU13M

### FEATURES:

- · High reverse voltage
- · Ultra fast recovery time

30

MAX

5.0

1.9

75

TYP

6.0

· Low leakage current

 $\Theta_{JL}$ 

1300

MAXIMUM RATINGS: (T <sub>A</sub> =25°C unless otherwise noted)		
Peak Repetitive Reverse Voltage	SYMBOL V <sub>RRM</sub>	1300
DC Blocking Voltage	°ккм Vв	1300
RMS Reverse Voltage	V <sub>R</sub> (RMS)	910
Average Forward Current ( $T_{\Delta}$ =75°C)	I <sub>O</sub>	1.0
Peak Forward Surge Current, tp=8.3ms	IFSM	30
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175

 ELECTRICAL
 CHARACTERISTICS:
 (T<sub>A</sub>=25°C unless otherwise noted)

 SYMBOL
 TEST CONDITIONS
 MIN
 TY

I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>rr</sub>=0.25A

V<sub>R</sub>=4.0V, f=1.0MHz

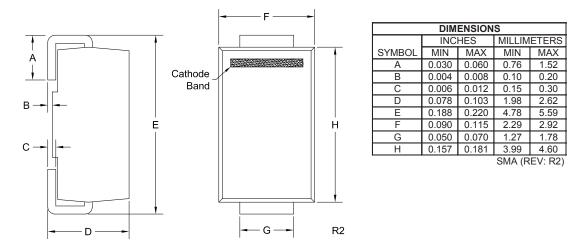
R2 (1-May 2015)



#### CMR1U-13M

SURFACE MOUNT SILICON ULTRA FAST RECOVERY RECTIFIER 1.0 AMP, 1300 VOLT

# SMA CASE - MECHANICAL OUTLINE



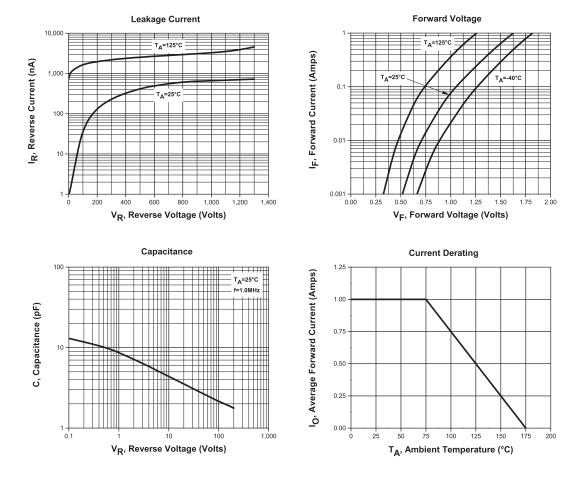
R2 (1-May 2015)

www.centralsemi.com



CMR1U-13M

SURFACE MOUNT SILICON ULTRA FAST RECOVERY RECTIFIER 1.0 AMP, 1300 VOLT



# TYPICAL ELECTRICAL CHARACTERISTICS

www.centralsemi.com

R2 (1-May 2015)

#### CMR1U-01M CMR1U-06M CMR1U-02M CMR1U-10M CMR1U-04M



SURFACE MOUNT SILICON ULTRA FAST RECOVERY RECTIFIERS 1.0 AMP, 100 THRU 1000 VOLT

### SERVICES

- · Bonded Inventory
- Custom Electrical Screening
- Custom Electrical Characteristic Curves
- SPICE Models
- Custom Packaging
- Package Base Options
- Custom Device Development/Multi Discrete Modules (MDM™)
- Bare Die Available for Hybrid Applications

LIMITATIONS AND DAMAGES DISCLAIMER: In no event shall Central be liable for any collateral, indirect, punitive, incidental, consequential, or exemplary damages in connection with or arising out of a purchase order or contract or the use of products provided hereunder, regardless of whether Central has been advised of the possibility of such damages. Excluded damages shall include, but not be restricted to: cost of removal or reinstallation, rework, ancillary costs to the procurement of substitute products, loss of profits, loss of savings, loss of use, loss of data, or business interruption. No claim, suit, or action shall be brought against Central more than two (2) years after the related cause of action has occurred.

In no event shall Central's aggregate liability from any warranty, indemnity, or other obligation arising out of or in connection with a purchase order or contract, or any use of any Central product provided hereunder, exceed the total amount paid to Central for the specific products sold under a purchase order or contract with respect to which losses or damages are claimed. The existence of more than one (1) claim against the specific products sold to Buyer under a purchase order or contract shall not enlarge or extend this limit.

Buyer understands and agrees that the foregoing liability limitations are essential elements of a purchase order or contract and that in the absence of such limitations, the material and economic terms of the purchase order or contract would be substantially different.

R6 (1-May 2015)

www.centralsemi.com